



ALPHA & OMEGA
SEMICONDUCTOR

AOT12N40

400V, 11A N-Channel MOSFET

General Description

The AOT12N40 is fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{DS(on)}$, C_{iss} and C_{rss} along with guaranteed avalanche capability this part can be adopted quickly into new and existing offline power supply designs.

For Halogen Free add "L" suffix to part number:
AOT12N40L

Product Summary

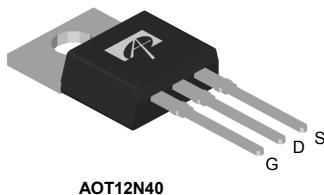
| | |
|---------------------------------|------------|
| V_{DS} | 500V@150°C |
| I_D (at $V_{GS}=10V$) | 11A |
| $R_{DS(ON)}$ (at $V_{GS}=10V$) | <0.59Ω |

100% UIS Tested
100% R_g Tested

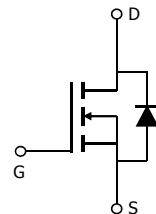


Top View

TO-220



AOT12N40



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Maximum | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage | V_{DS} | 400 | V |
| Gate-Source Voltage | V_{GS} | ± 30 | V |
| Continuous Drain Current | I_D | 11 | A |
| $T_C=100^\circ\text{C}$ | I_D | 7 | |
| Pulsed Drain Current ^C | I_{DM} | 28 | A |
| Avalanche Current ^C | I_{AR} | 3.5 | A |
| Repetitive avalanche energy ^C | E_{AR} | 184 | mJ |
| Single pulsed avalanche energy ^G | E_{AS} | 368 | mJ |
| Peak diode recovery dv/dt | dv/dt | 5 | V/ns |
| Power Dissipation ^B | P_D | 184 | W |
| Derate above 25°C | P_D | 1.5 | W/ °C |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |
| Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds | T_L | 300 | °C |

Thermal Characteristics

| Parameter | Symbol | Typical | Maximum | Units |
|---|-----------------|---------|---------|-------|
| Maximum Junction-to-Ambient ^{AD} | $R_{\theta JA}$ | 54 | 65 | °C/W |
| Maximum Case-to-sink ^A | $R_{\theta CS}$ | - | 0.5 | °C/W |
| Maximum Junction-to-Case | $R_{\theta JC}$ | 0.56 | 0.68 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|----------------------------------|---------------------------------------|---|-----|------|------|-------|
| STATIC PARAMETERS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | I _D =250μA, V _{GS} =0V, T _J =25°C | 400 | | | V |
| | | I _D =250μA, V _{GS} =0V, T _J =150°C | | 500 | | |
| BV _{DSS} / ΔT_J | Zero Gate Voltage Drain Current | I _D =250μA, V _{GS} =0V | | 0.4 | | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =400V, V _{GS} =0V | | | 1 | μA |
| | | V _{DS} =320V, T _J =125°C | | | 10 | |
| I _{GSS} | Gate-Body leakage current | V _{DS} =0V, V _{GS} =±30V | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =5V, I _D =250μA | 3.3 | 3.9 | 4.5 | V |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} =10V, I _D =6A | | 0.49 | 0.59 | Ω |
| g _{FS} | Forward Transconductance | V _{DS} =40V, I _D =6A | | 10 | | S |
| V _{SD} | Diode Forward Voltage | I _S =1A, V _{GS} =0V | | 0.72 | 1 | V |
| I _S | Maximum Body-Diode Continuous Current | | | | 11 | A |
| I _{SM} | Maximum Body-Diode Pulsed Current | | | | 28 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C _{iss} | Input Capacitance | V _{GS} =0V, V _{DS} =25V, f=1MHz | 740 | 925 | 1110 | pF |
| C _{oss} | Output Capacitance | | 70 | 100 | 130 | pF |
| C _{rss} | Reverse Transfer Capacitance | | 3.5 | 6.4 | 9.0 | pF |
| R _g | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1MHz | 1.4 | 2.9 | 4.5 | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q _g | Total Gate Charge | V _{GS} =10V, V _{DS} =320V, I _D =12A | 13 | 17 | 21 | nC |
| Q _{gs} | Gate Source Charge | | | 5.4 | | nC |
| Q _{gd} | Gate Drain Charge | | | 5.7 | | nC |
| t _{D(on)} | Turn-On DelayTime | V _{GS} =10V, V _{DS} =200V, I _D =12A, R _G =25Ω | | 25 | | ns |
| t _r | Turn-On Rise Time | | | 57 | | ns |
| t _{D(off)} | Turn-Off DelayTime | | | 41 | | ns |
| t _f | Turn-Off Fall Time | | | 32 | | ns |
| t _{rr} | Body Diode Reverse Recovery Time | I _F =12A, dI/dt=100A/μs, V _{DS} =100V | 180 | 235 | 290 | ns |
| Q _{rr} | Body Diode Reverse Recovery Charge | I _F =12A, dI/dt=100A/μs, V _{DS} =100V | 1.9 | 2.4 | 2.9 | μC |

A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25°C.

B. The power dissipation P_D is based on T_{J(MAX)=150°C}, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)=150°C}. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

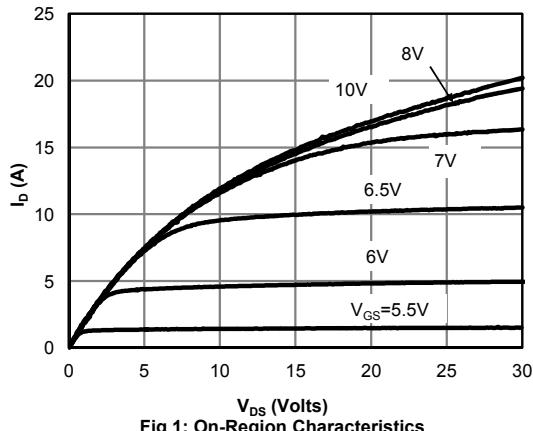
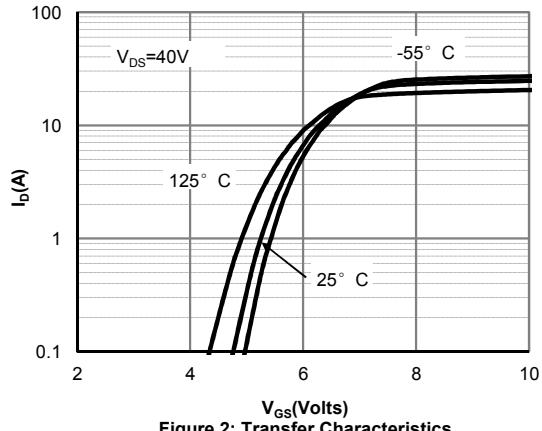
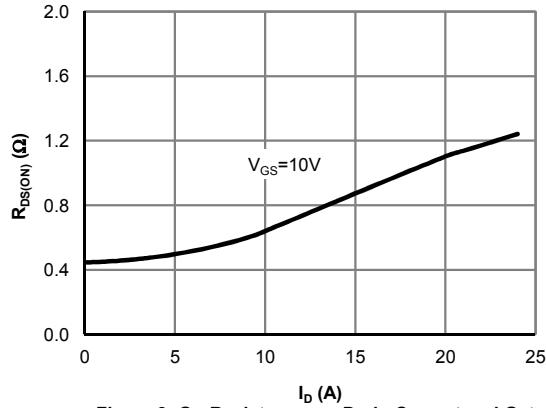
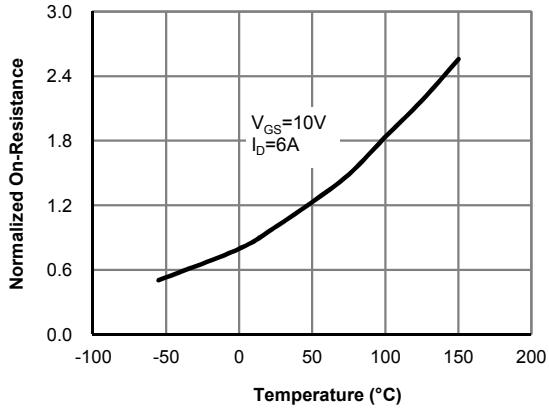
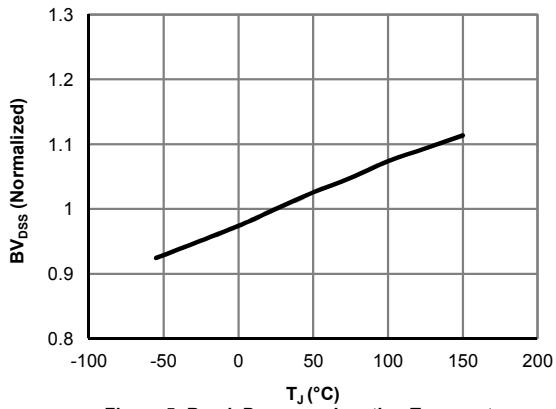
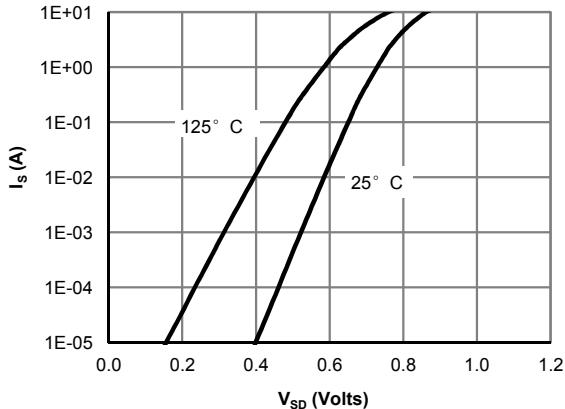
D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

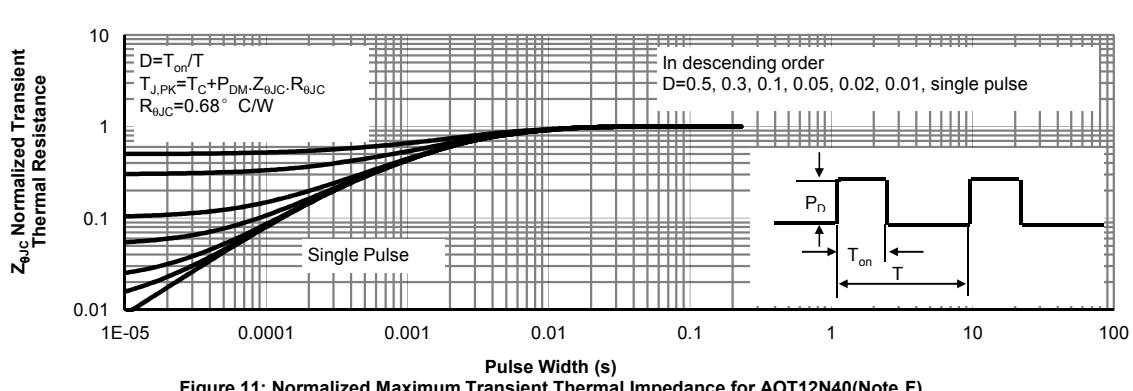
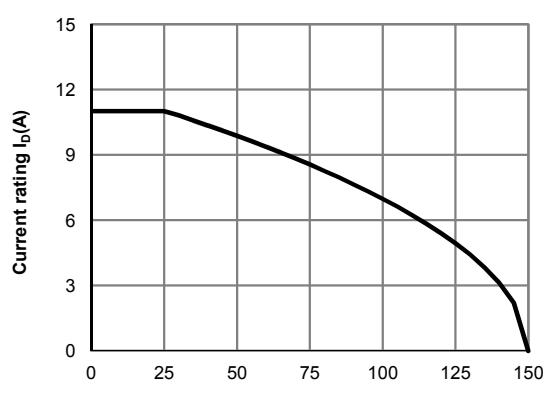
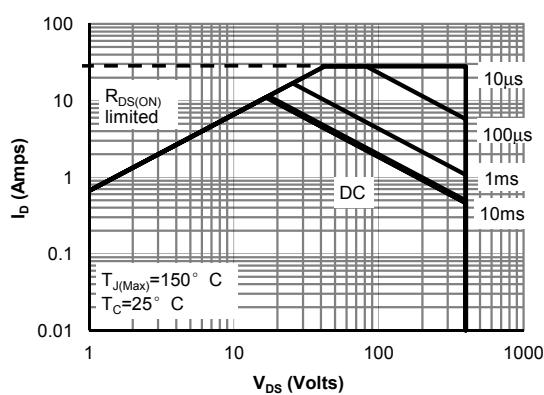
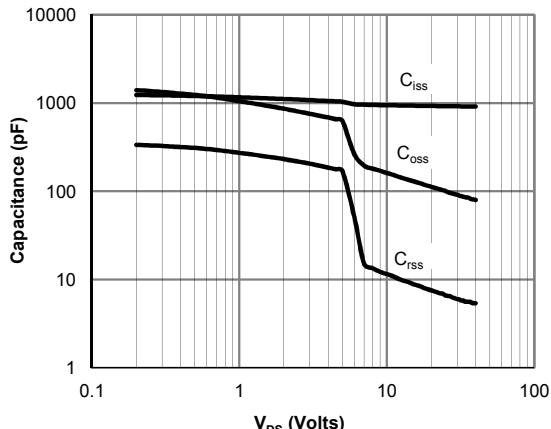
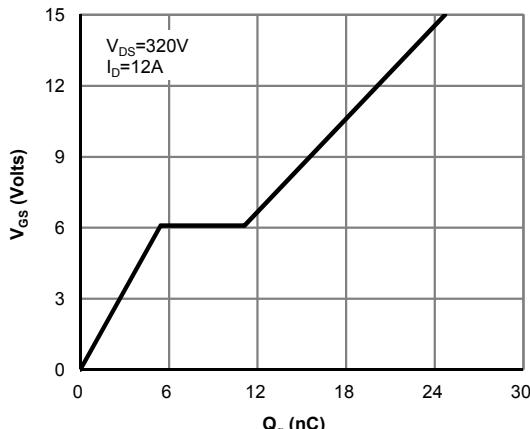
E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

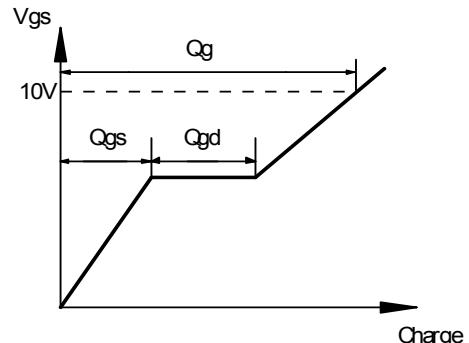
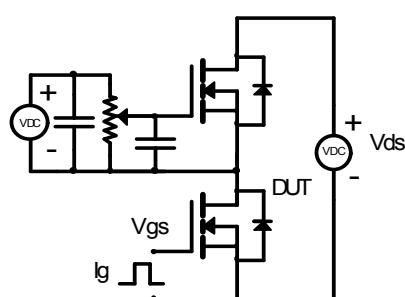
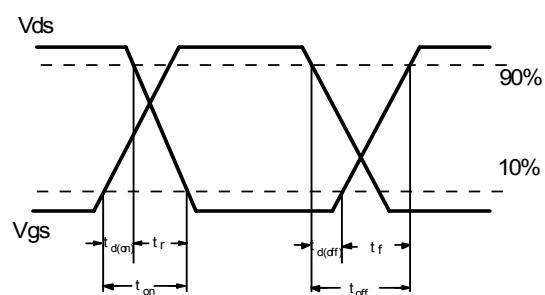
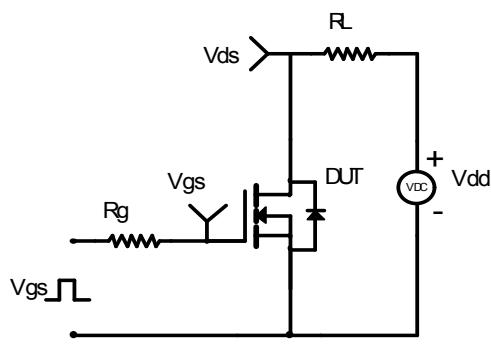
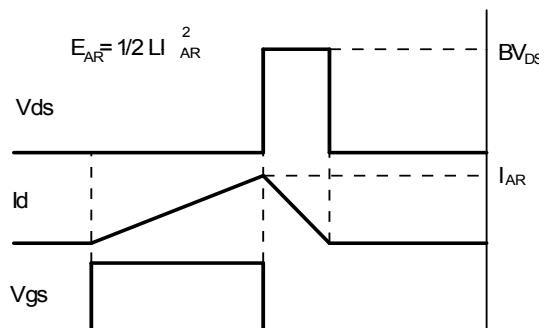
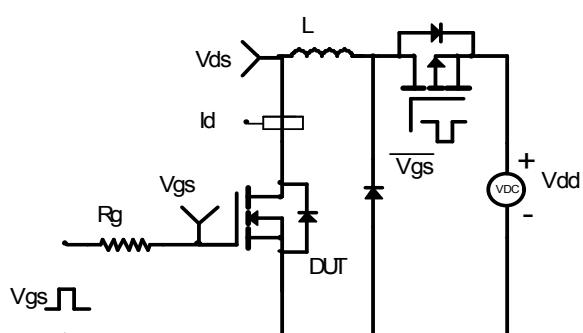
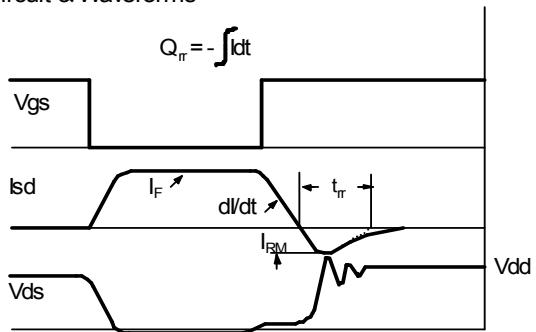
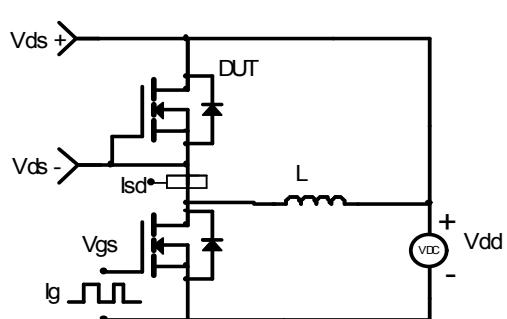
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)=150°C}. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=3.5A, V_{DD}=150V, R_G=25Ω, Starting T_J=25°C

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: Break Down vs. Junction Temperature

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Gate Charge Test Circuit & Waveform

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